

Docket No.: M4065.0184/P184-A
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Alan G. Wood et al.

Application No.: New (Divisional of 09/594,510) Prior Group Art Unit: 2815

Filed: August 16, 2001 Prior Examiner: C. Chu

For: SEMICONDUCTOR DEVICE PACKAGE
AND METHOD

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, DC 20231

Dear Sir:

Preliminary to examination, please amend the above-captioned application as follows:

In the Specification:

Page 2, at the top of the page, before the heading FIELD OF THE INVENTION, insert the following new paragraph:

This application is a divisional of U.S. Patent Application No. 09/594,510, filed June 16, 2000, the entire disclosure of which is incorporated herein by reference.

In the Claims:

Cancel claims 1-23 and 35-38, without prejudice.

REMARKS

This Preliminary Amendment is being filed together with a divisional application. The original method claims have been cancelled to reduce the filing fee. Applicants reserve the right to pursue the original claims and other claims in this application and in other applications. Favorable action on the merits is respectfully requested.

Dated: August 15, 2001

Respectfully submitted,

By 

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